

STGB20NB37LZ

N-CHANNEL CLAMPED 20A D²PAK INTERNALLY CLAMPED PowerMESHTM IGBT

PRELIMINARY DATA

TYPE	V _{CES}	V _{CE(sat)}	Ic
STGB20NB37LZ	CLAMPED	< 2.0 V	20 A

- POLYSILICON GATE VOLTAGE DRIVEN
- LOW THRESHOLD VOLTAGE
- LOW ON-VOLTAGE DROP
- HIGH CURRENT CAPABILITY
- HIGH VOLTAGE CLAMPING FEATURE
- SURFACE-MOUNTING D²PAK (TO-263)
 POWER PACKAGE IN TUBE (NO SUFFIX)
 OR IN TAPE & REEL (SUFFIX "T4")

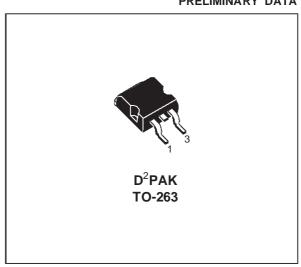
DESCRIPTION

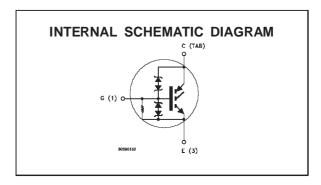
Using the latest high voltage technology based on patented strip layout, STMicroelectronics has designed an advanced family of IGBTs with outstanding performances.

The built in collector-gate zener exhibits a very precise active clamping while the gate-emitter zener supplies an ESD protection.

APPLICATIONS

■ AUTOMOTIVE IGNITION





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage (V _{GS} = 0)	CLAMPED	V
V _{ECR}	Reverse Battery Protection	20	V
V_{GE}	Gate-Emitter Voltage	CLAMPED	V
Ic	Collector Current (continuous) at T _c = 25 °C	40	А
Ic	Collector Current (continuous) at T _c = 100 °C	30	А
I _{CM} (•)	Collector Current (pulsed)	80	А
E _{AS}	Single Pulse Energy Tc = 25 °C	700	mJ
P _{tot}	Total Dissipation at T _c = 25 °C	150	W
	Derating Factor	1	W/°C
E _{SD}	ESD (Human Body Model)	4	KV
T _{stg}	Storage Temperature	-65 to 175	°C
Tj	Max. Operating Junction Temperature	175	°C

(•) Pulse width limited by safe operating area

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THERMAL DATA

Γ	R _{thj-case}	Thermal	Resistance	Junction-case	Max	1	°C/W
	R _{thj-amb}	Thermal	Resistance	Junction-ambient	Max	62.5	°C/W
	R _{thc-sink}	Thermal	Resistance	Case-sink	Тур	0.2	°C/W

ELECTRICAL CHARACTERISTICS ($T_j = 25$ $^{\circ}C$ unless otherwise specified)

OFF

Symbol	Parameter	Tes	t Conditi	ons	Min.	Тур.	Max.	Unit
BV _(CES)	Clamped Voltage	I _C =2mA I _C =2mA I _C =2mA		$T_C = -40$ °C $T_C = 25$ °C $T_C = 150$ °C	380 375 370	405 400 395	430 425 420	V V V
BV _(ECR)	Emitter Collector Break-down Voltage	I _C = 75 mA		$T_C = 25^{\circ}C$	20	28		V
BV _{GE}	Gate Emitter Break-down Voltage	I _G =± 2 mA			12	14	16	V
I _{CES}	Collector cut-off Current (VGE = 0)	V _{CE} = 15 V V _{CE} = 200 V	$V_{GE} = 0$ $V_{GE} = 0$	$T_{C} = 150 {}^{\circ}\text{C}$ $T_{C} = 150 {}^{\circ}\text{C}$			10 100	μΑ μΑ
I _{GES}	Gate-Emitter Leakage Current (VCE = 0)	V _{GE} = ± 10 V		V _{CE} = 0	± 300	± 660	± 1000	μА
R _{GE}	Gate Emitter Resistance				10	15	30	ΚΩ

ON (*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{GE(th)}	Gate Threshold Voltage	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	1.0	1.4	2	V V V
V _{CE} (SAT)	Collector-Emitter Saturation Voltage	$\begin{array}{cccccccccccccccccccccccccccccccccccc$		1.1 1.0 1.35 1.25	1.8 1.7 2.0 2.0	V V V

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
9fs	Forward Transconductance	$V_{CE} = 25 \text{ V}$ $I_{C} = 20 \text{ A}$		35		S
C _{ies} C _{oes} C _{res}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{CE} = 25 V f = 1 MHz V _{GE} = 0		2300 165 28		pF pF pF
Q _G	Gate Charge	$V_{CE} = 280 \text{ V}$ $I_{C} = 20 \text{ A}$ $V_{GE} = 5 \text{ V}$		51		nC

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FUNCTIONAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
II	Latching Current	$V_{\text{CLAMP}} = 250 \text{ V}$ $V_{\text{GE}} = 4.5 \text{ V}$ $V_{\text{GOFF}} = 1 \text{ K}\Omega$ $V_{\text{C}} = 150 \text{ °C}$	80			А
U.I.S.		$\begin{array}{cccccccccccccccccccccccccccccccccccc$		26 18		A A

SWITCHING ON

Symbol	Parameter	Test Conditi	Min.	Тур.	Max.	Unit	
t _{d(on)}	Delay Time Rise Time	V _{CC} = 250 V V _{GE} = 4.5 V	$I_C = 20 A$ $R_G = 1 K\Omega$		2.3 0.6		μs μs
(di/dt) _{on}	Turn-on Current Slope	$V_{CC} = 250 \text{ V}$ $R_G = 1 \text{ K}\Omega$	I _C = 20 A V _{GE} = 4.5 V		550		A/μs
Eon	Turn-on Switching Losses	$V_{CC}=250V$ $I_{C}=20A$ $R_{G}=1$ $K\Omega$ $V_{GE}=4.5V$	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 150 ^{\circ}\text{C}$		8.8 9.2		mJ mJ

SWITCHING OFF

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
t _c	Cross-Over Time	$V_{CC} = 250 \text{ V}$	$I_{C} = 20 \text{ A}$		4.8		μs
$t_r(v_{off})$	Off Voltage Rise Time	$R_{GE} = 1 K\Omega$	$V_{GE} = 4.5 V$		2.6		μs
t _f	Fall Time				2.0		μs
t _d (off)	Off Voltage Delay Time				11.5		μs
E _{off} (**)	Turn-off Switching Loss				11.8		mJ
tc	Cross-Over Time	V _{CC} = 250 V	$I_{C} = 20 \text{ A}$		7.8		μs
$t_r(v_{off})$	Off Voltage Rise Time	$R_{GE} = 1 K\Omega$	$V_{GE} = 4.5 V$		3.5		μs
t _f	Fall Time	$T_C = 150 ^{\circ}C$			3.9		μs
t _d (off)	Off Voltage Delay Time				12.0		μs
E _{off} (**)	Turn-off Switching Loss				17.8		mJ

^(*) Pulse width limited by safe operating area (*) Pulsed: Pulse duration = 300 ms, duty cycle 1.5 % (**)Losses Include Also The Tail (jedec Standardization)

Fig. 1: Unclamped Inductive Load Test Circuit

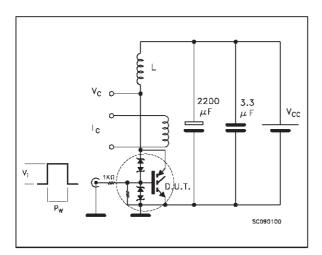


Fig. 3: Switching Times Test Circuits For Resistive Load

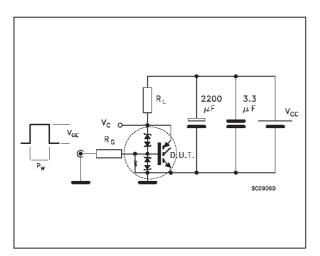


Fig. 5: Test Circuit For Inductive Load Switching And Dlode Recovery Times

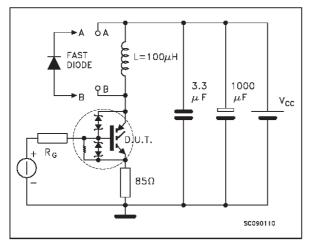


Fig. 2: Unclamped Inductive Waveform

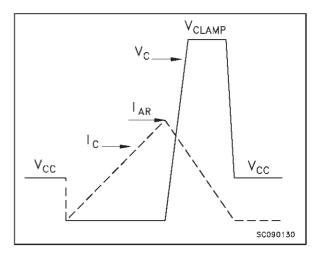
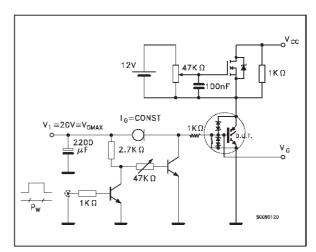


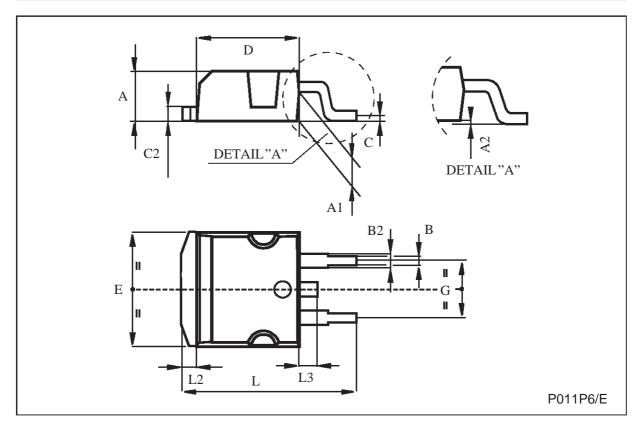
Fig. 4: Gate Charge test Circuit



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TO-263 (D²PAK) MECHANICAL DATA

DIM.	mm inch			inch		
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.4		4.6	0.173		0.181
A1	2.49		2.69	0.098		0.106
В	0.7		0.93	0.027		0.036
B2	1.14		1.7	0.044		0.067
С	0.45		0.6	0.017		0.023
C2	1.21		1.36	0.047		0.053
D	8.95		9.35	0.352		0.368
E	10		10.4	0.393		0.409
G	4.88		5.28	0.192		0.208
L	15		15.85	0.590		0.624
L2	1.27		1.4	0.050		0.055
L3	1.4		1.75	0.055		0.068



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